

AA4040VRBXZ1S/A-2A

4.0 x 4.0 mm Right Angle Surface Mount LED Lamp



0.3(0.012)

2.9(0.114)

4(0.157)±0.1

Cu-area≥16mm²

4

per pad

3.6(0.142)

chip

Z1

° 2

0.7(0.028)

5

2.85(0.112)

1.7

DESCRIPTIONS

- The source color devices are made with InGaN Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- Single color
- Suitable for all SMD assembly and solder process
- · Available on tape and reel
- Ideal for backlighting
- Package: 500 pcs / reel
- · Moisture sensitivity level: 2a
- RoHS compliant

APPLICATIONS

- Traffic signaling
- · Backlighting (illuminated advertising, general lighting)
- · Interior and exterior automotive lighting
- Substitution of micro incandescent lamps
- Reading lamps
- Signal and symbol luminaire for orientation
- Marker lights (e.g. Steps, exit ways, etc)
- · Decorative and entertainment lighting
- · Indoor and outdoor commercial and residential architectural lighting

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices



Notes All dimensions are in millimeters (inches).
 Tolerance is ±0.25(0.01") unless otherwise noted.

(units : mm; tolerance : ± 0.1)

4.2

PACKAGE DIMENSIONS

Polarity mark

2.6(0.102)

Δ

1.4(0.055)

R1

4(0.157)

2.4(0.094)

1(0.039)

2.54(0.1)

Spacing

RECOMMENDED SOLDERING PATTERN

Pad design for improved heat dissipation

2

3. The specifications, characteristics and technical data described in the datasheet are subject to

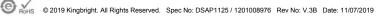
change without prior notice. 4. The device has a single mounting surface. The device must be mounted according to the specifications.

Solder resist

SELECTION GUIDE

Deut Number	Emitting Color	lv (mcd) @ 20mA ^[2]			Viewing Angle [1]	
Part Number	(Material)		Min.	Max.	201/2	
AA4040VRBXZ1S/A-2A		Т	700	1000		
		U	1000	1300		
	Blue (InGaN)	V	1300	1600	120	
		W	1600	1900	†	

- Notes: 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value
- Luminous intensity / luminous flux: +/-15%.
 Luminous intensity value is traceable to CIE127-2007 standards.



ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Symbol Emitting Color	Value		Unit
Falameter	Symbol		Тур.	Max.	Unit
Chromaticity Coordinates x $I_F = 20mA$	x ^[1]	Blue	0.21	-	-
Chromaticity Coordinates y $I_F = 20mA$	у [1]	Blue	0.20	-	-
Capacitance	С	Blue	100	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Blue	3.3	4.0	V
Reverse Current (V _R = 5V)	I _R	Blue	-	50	μA
Temperature Coefficient of x I_F = 20mA, -10°C $\leq T \leq$ 100°C	TC _x	Blue	-0.16	-	10⁻³/°C
Temperature Coefficient of y I_F = 20mA, -10°C $\leq T \leq$ 100°C	TCy	Blue	-0.18	-	10 ⁻³ /°C
Temperature Coefficient of V_F I _F = 20mA, -10°C \leq T \leq 100°C	TCv	Blue	-3.0	-	mV/°C

Notes:

Measurement tolerance of the chromaticity coordinates is ±0.01.
 Forward voltage: ±0.1V.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

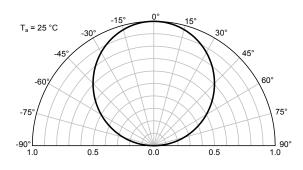
ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	PD	120	mW
Reverse Voltage	V _R	5	V
Junction Temperature	Tj	100	°C
Operating Temperature	T _{op}	-40 to +100	°C
Storage Temperature	T _{stg}	-40 to +110	°C
DC Forward Current	I _F	30	mA
Peak Forward Current	I _{FM} ^[1]	100	mA
Electrostatic Discharge Threshold (HBM)	-	8000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	340	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[2]	220	°C/W

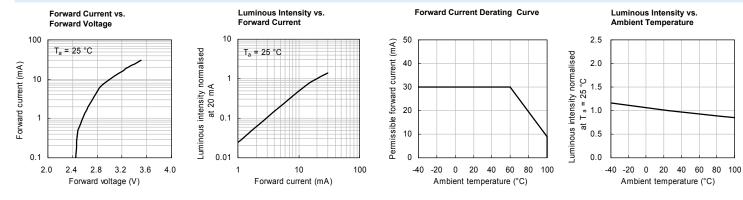
Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. $R_{In, IS}$ Results from mounting on PC board FR4 (pad size \geq 16 mm² per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

TECHNICAL DATA

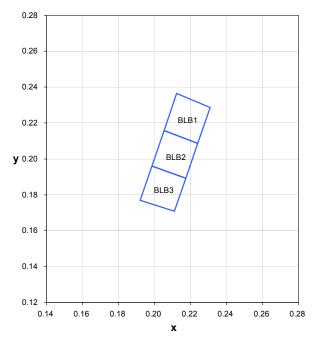
SPATIAL DISTRIBUTION



BLUE



CIE CHROMATICITY DIAGRAM

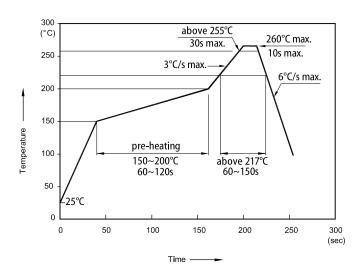


	X	У
BLB1	0.2123	0.2364
	0.2053	0.2158
	0.2240	0.2086
	0.2310	0.2286
BLB2	0.2053	0.2158
	0.1985	0.1960
	0.2173	0.1893
	0.2240	0.2086
BLB3	0.1985	0.1960
	0.1920	0.1769
	0.2109	0.1707
	0.2173	0.1893

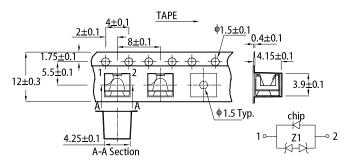
Notes:

Shipment may contain more than one chromaticity regions. Orders for single chromaticity region are generally not accepted. Measurement tolerance of the chromaticity coordinates is ±0.01.

REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



TAPE SPECIFICATIONS (units : mm)



REEL DIMENSION (units : mm)

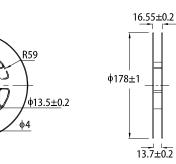
2.1±0.2

30

6

33.5

83



Notes

Don't cause stress to the LEDs while it is exposed to high temperature.
 The maximum number of reflow soldering passes is 2 times.

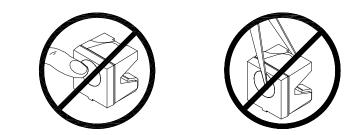
3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

HANDLING PRECAUTIONS

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



3. As silicone encapsulation is permeable to gases, some corrosive substances such as H₂S might corrode silver plating of lead frame. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

RELIABILITY TEST ITEMS AND CONDITIONS

The reliability of products shall be satisfied with items listed below

LOT TOLERANCE PERCENT DEFECTIVE (LTPD): 10%

No.	Test Item	Standards	Test Condition	Test Times / Cycles	Number of Damaged
1	Continuous operating test	-	T_a = 25°C, I_F = maximum rated current *	1,000 h	0 / 22
2	High Temp. operating test	EIAJ ED-4701/100(101)	$T_a = 100^{\circ}C$, $I_F = maximum rated current *$	1,000 h	0 / 22
3	Low Temp. operating test	-	T_a = -40°C, I _F = maximum rated current *	1,000 h	0 / 22
4	High temp. storage test	EIAJ ED-4701/100(201)	T _a = maximum rated storage temperature	1,000 h	0 / 22
5	Low temp. storage test	EIAJ ED-4701/100(202)	T _a = -40°C	1,000 h	0 / 22
6	High temp. & humidity storage test	-	T _a = 60°C, RH = 90%	500 h	0 / 22
7	High temp. & humidity operating test	-	$T_a = 60^{\circ}C$, RH = 90% I _F = maximum rated current *	500 h	0 / 22
8	Soldering reliability test	EIAJ ED-4701/100(301)	Moisture soak: 30°C, 70% RH, 72h Preheat: 150~180°C (120s max.) Soldering temp: 260°C(10s)	2 times	0 / 18
9	Thermal shock operating test	-	$T_a = -40^{\circ}C(15min) \sim 100^{\circ}C(15min)$ $I_F = derated current at 100^{\circ}C$	1,000 cycles	0 / 22
10	Thermal shock test	-	T _a = -40°C(15min) ~ maximum rated storage temperature(15min)	1,000 cycles	0 / 22
11	Electric Static Discharge (ESD)	EIAJ ED-4701/100(304)	C = 100pF, R2 = 1.5KΩ V = 8000V	Once each Polarity	0 / 22
12	Vibration test	-	a = 196m/s ² , f = 100~2KHz, t = 48min for all xyz axes	4 times	0 / 22

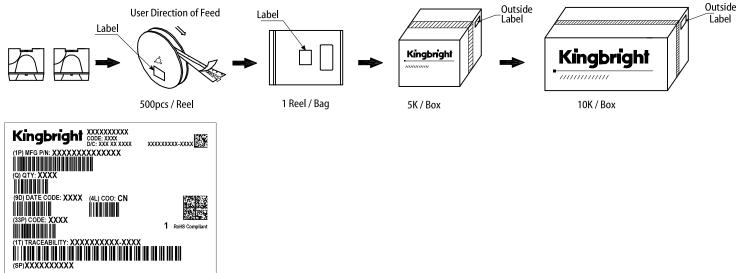
*: Refer to forward current vs. derating curve diagram

CRITERIA FOR JUDGING DAMAGE

Items	Symbols	Conditions	Failure Criteria	
luminous Intensity	Ι _V	I _F = 20mA	Testing Min. Value < Spec. Min. Value x 0.5	
Forward Voltage	V _F	I _F = 20mA	Testing Max. Value ≥ Spec. Max. Value x 1.2	
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage	Testing Max. Value ≥ Spec. Max. Value x 2.5	
High temp. storage test	-	-	Occurrence of notable decoloration, deformation and cracking	

AA4040VRBXZ1S/A-2A

PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

- 1.
- The information included in this document reflects representative usage scenarios and is intended for technical reference only. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening 3.
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- 5.
- 6. Notes